13.56-MHz ENCAPSULATED PLUS TRANSPONDER

FEATURES

- **ISO/IEC 15693-2,-3; ISO/IEC 18000-3 Compliant**
- **13.56-MHz Operating Frequency**
- **2048-Bit User Memory in 64 × 32-bit Blocks**
- **User and Factory Lock Per Block**
- **Application Family Identifier (AFI)**
- **Data Storage Format Identifier (DSFID)**
- **Combined Inventory Read Block**

APPLICATIONS

- **Laundry**
- **Process Automation**
- **Product Authentication**
- **Asset Management**

DESCRIPTION

Texas Instruments' 13.56-MHz encapsulated plus transponder is compliant with the ISO/IEC 15693 and ISO/IEC 18000-3 global open standards. This product offers a user accessible memory of 2048 bits, organized in 64 blocks and an extensive command set.

Designed for harsh environments, such as garment tracking in laundries, each transponder has a 64-bit factory programmed Read Only Number, which is also laser engraved on the transponder housing. Prior to delivery, transponders undergo complete functional and parametric testing to provide the high quality that customers have come to expect from TI.

The 13.56-MHz encapsulated plus transponders are well suited for a variety of applications including but not limited to: laundry garment tracking, process automation, product authentication, and asset management.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)

	RF-HDT-DVBB	UNIT
Operating Temperature	–25 to 90	°C
Storage Temperature	–40 to 120 (130°C for total 50 hours, 220°C for total 30 seconds)	°C

OPERATING CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

PARAMETER	RF-HDT-DVBB(1)	UNIT
Supported standard	ISO/IEC 15693-2,-3; ISO/IEC 18000-3	
Resonance frequency (at 25°C)	13.56 MHz ± 300 kHz	
Typ. required activation field strength to read (at 25°C)	112	dBµA/m
Typ. required activation field strength to write (at 25°C)	115	dBµA/m
Factory programmed read only number	64	bits
Memory (user programmable)	2k bits organized in 64 × 32-bit blocks	
Typical programming cycles (at 25°C)	100 000	
Data retention time (at 25°C)	>10 years	
Simultaneous identification of tags	Up to 50 tags per second (reader/antenna dependent)	
Dimensions	ø 22 ± 0.2 mm × 3 ± 0.2 mm	
Weight	2.1 ± 0.2	grams
Case material	PPS, black	
Protection class	IP 68	
Vibration	ISO/IEC 68.2.6 (10 g, 10 to 2000 Hz, 3 axis, 2.5 h)	
Mechanical shock	ISO/IEC 68.2.27 (100 g, 6 ms, 6 axis, 20 times per axis)	
Mechanical stability	Axial compression strength: 1000 N (10 s, static) Radial compression strength: 500 N (10 s, static) Isostatic water pressure: 45 bar (10 h)	
Chemical resistance	Typical chemicals used in laundry and dry-cleaning processes	
Delivery	1000 units in bulk	

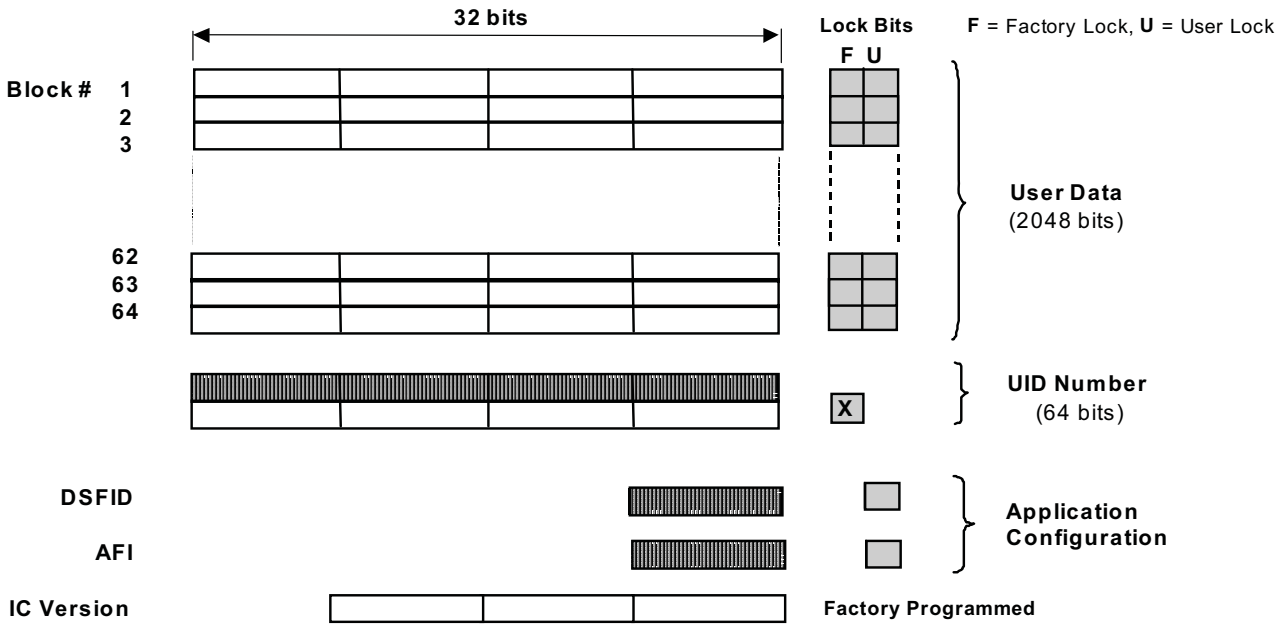
(1) For highest possible read-out coverage, TI recommends operation of readers at a modulation depth of 20% or higher.

SUPPORTED COMMAND SET

REQUEST	REQUEST MODE(1)					
	REQUEST CODE	INVENTORY	ADDRESSED	NON-ADDRESSED	SELECT	AFI
ISO 15693 Mandatory and Optional Commands						
Inventory	0x01	√	–	–	–	√
Stay Quiet	0x02	–	√	–	–	–
Read_Single_Block	0x20	√	√	√	√	√
Write_Single_Block	0x21	–	√	√	√	–
Lock_Block	0x22	–	√	√	√	–
Read_Multi_Blocks	0x23	√	√	√	√	√
Write_Multi-Blocks	0x24	–	–	–	–	–
Select Tag	0x25	–	√	–	–	–
Reset to Ready	0x26	–	√	√	√	–
Write_AFI	0x27	–	√	√	√	–
Lock_AFI	0x28	–	√	√	√	–
Write DSFID	0x29	–	√	√	√	–
Lock DSFID	0x2A	–	√	√	√	–
Get_System_info	0x2B	√	√	√	√	√
Get_M_BLK_Sec_St	0x2C	√	√	√	√	√
TI Custom Commands						
Write_2_Blocks	0xA2	–	√	√	√	–
Lock_2_Blocks	0xA3	–	√	√	√	–

(1) √: Implemented, – : Not applicable

MEMORY ORGANIZATION



PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
RF-HDT-DVBB-N2	Active	Production	RFIDP (TEC) | 0	1000 | BULK	Yes	Call TI	Call TI	-25 to 90	
RF-HDT-DVBB-N2.B	Active	Production	RFIDP (TEC) | 0	1000 | BULK	-	Call TI	Call TI	-25 to 90	

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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